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IRFY430C, IRFY430CM

**HEXFET<sup>®</sup> MOSFET TECHNOLOGY** 

<u>急出货</u> PD - 91291C

W.DZ

**500V, N-CHANNEL** 

### International ICR Rectifier **POWER MOSFET** THRU-HOLE (TO-257AA)

#### **Product Summary**

Part Number	RDS(on)	ID	Eyelets	
IRFY430C	1.5 Ω	4.5A	Ceramic	
IRFY430CM	1.5 Ω	4.5A	Ceramic	

HEXFET<sup>®</sup> MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.

# **TO-257AA**

### Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Ceramic Eyelets
- Ideally Suited For Space Level Applications

	Parameter		Units
ID @ VGS = 10V, TC = 25°C	Continuous Drain Current	4.5	
$I_D @ V_{GS} = 10V, T_C = 100^{\circ}C$	Continuous Drain Current	2.8	A
IDM	Pulsed Drain Current 1	18	
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Max. Power Dissipation	75	W
	Linear Derating Factor	0.6	W/°C
VGS	Gate-to-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy 2	280	mJ
IAR	Avalanche Current ①	4.5	A
EAR	Repetitive Avalanche Energy ①	7.5	mJ
dv/dt	Peak Diode Recovery dv/dt 3	3.5	V/ns
ТJ	Operating Junction	-55 to 150	
P TSTG	Storage Temperature Range		°C
,找 🔁 PDF	Lead Temperature	300(0.063in./1.6mm from case for 10 sec)	
	Weight	4.3 (Typical)	g

### Absoluto Maximum Patings

odt.dzsc.com For footnotes refer to the last page

### IRFY430C, IRFY430CM

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### Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	500	_	_	V	VGS = 0V, ID = 1.0mA
ΔBV <sub>DSS</sub> /ΔTJ	Temperature Coefficient of Breakdown Voltage	_	0.78	_	V/°C	Reference to 25°C, ID = 1.0mA
RDS(on)	Static Drain-to-Source On-State Resistance	—	—	1.5	Ω	VGS = 10V, ID = 2.8A ④
VGS(th)	Gate Threshold Voltage	2.0	_	4.0	V	$V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$
9fs	Forward Transconductance	1.5	—	—	S (ひ)	V <sub>DS</sub> > 15V, I <sub>DS</sub> = 2.8A ④
IDSS	Zero Gate Voltage Drain Current	_	_	25		VDS= 400V ,VGS=0V
		_	—	250	μA	VDS = 400V,
						VGS = 0V, TJ = 125°C
IGSS	Gate-to-Source Leakage Forward	_	—	100		VGS = 20V
IGSS	Gate-to-Source Leakage Reverse		—	-100	nA	VGS = -20V
Qg	Total Gate Charge		—	29.5		VGS =10V, ID = 4.5A
Qgs	Gate-to-Source Charge	_	—	4.6	nC	VDS = 250V
Qgd	Gate-to-Drain ('Miller') Charge		—	19.7	1	
td(on)	Turn-On Delay Time	—	—	35		$V_{DD} = 250V, I_D = 4.5A,$
tr	Rise Time	_	—	30		RG = 7.5Ω
td(off)	Turn-Off Delay Time		—	55	ns	
tf	Fall Time	—	—	30		
LS+LD	Total Inductance	_	6.8	_	nH	Measured from drain lead (6mm/0.25in. from package) to source lead (6mm/0.25in. from package)
Ciss	Input Capacitance	_	650	_		VGS = 0V, VDS = 25V
Coss	Output Capacitance	—	135	—	pF	f = 1.0MHz
C <sub>rss</sub>	Reverse Transfer Capacitance	_	65	_		

### **Source-Drain Diode Ratings and Characteristics**

	Parameter	Min	Тур	Max	Units	Test Conditions
IS	Continuous Source Current (Body Diode)	_	_	4.5	^	
ISM	Pulse Source Current (Body Diode) ①	—	—	18	A	
VSD	Diode Forward Voltage	—	—	1.4	V	$T_j = 25^{\circ}C$ , $I_S = 4.5A$ , $V_{GS} = 0V$ (4)
trr	Reverse Recovery Time		—	900	nS	Tj = 25°C, IF = 4.5A, di/dt ≤ 100A/μs
QRR	Reverse Recovery Charge	—	—	7.0	μC	$V_{DD} \le 50V $
ton	Forward Turn-On Time Intrinsic turn-on	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by LS + LD.				

### **Thermal Resistance**

	Parameter	Min	Тур	Max	Units	Test Conditions
RthJC	Junction-to-Case	—	—	1.67		
RthCS	Case-to-sink	—	0.21	—	°C/W	
RthJA	Junction-to-Ambient	—	—	80		Typical socket mount

#### Note: Corresponding Spice and Saber models are available on the G&S Website.

For footnotes refer to the last page

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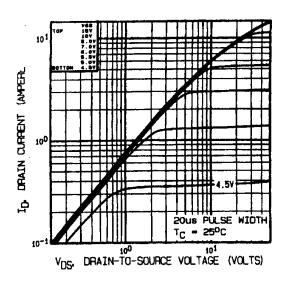


Fig 1. Typical Output Characteristics

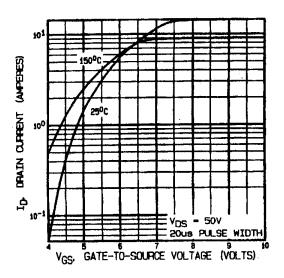


Fig 3. Typical Transfer Characteristics

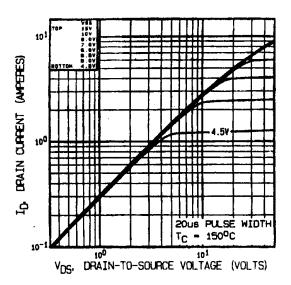


Fig 2. Typical Output Characteristics

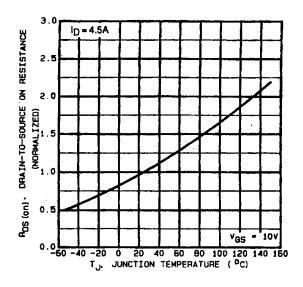


Fig 4. Normalized On-Resistance Vs. Temperature

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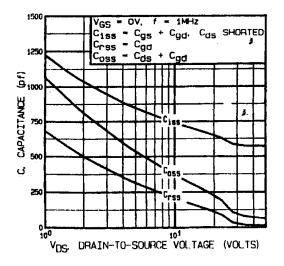


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

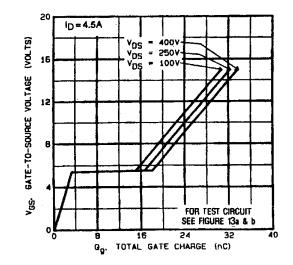
REVERSE CRAIN CURRENT (AMPERES)

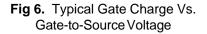
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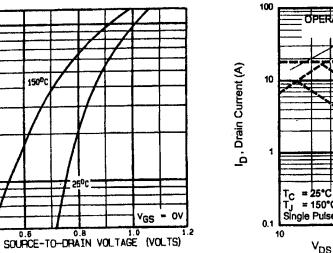
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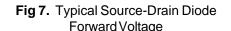
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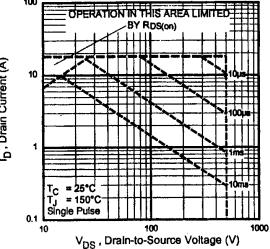


Fig 8. Maximum Safe Operating Area

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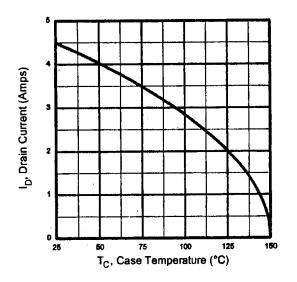


Fig 9. Maximum Drain Current Vs. Case Temperature

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Fig 10a. Switching Time Test Circuit

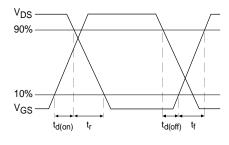


Fig 10b. Switching Time Waveforms

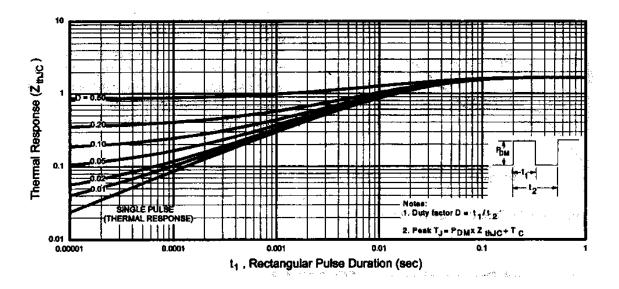


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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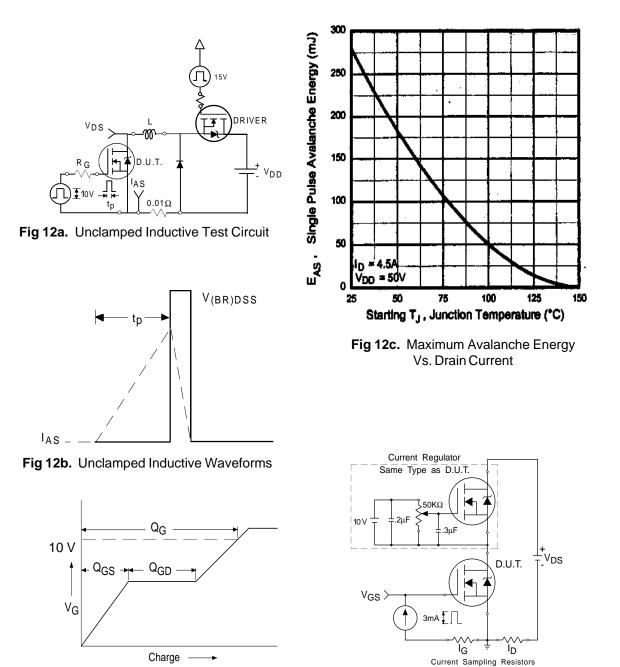


Fig 13a. Basic Gate Charge Waveform

Fig 13b. Gate Charge Test Circuit

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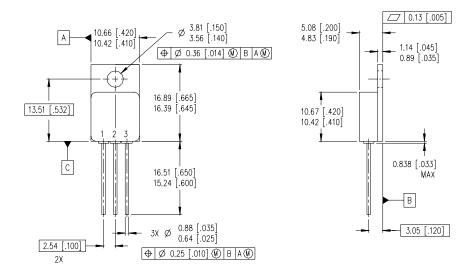
### IRFY430C, IRFY430CM

### Footnotes:

- Repetitive Rating; Pulse width limited by maximum junction temperature.
- V<sub>DD</sub> = 50V, starting T<sub>J</sub> = 25°C, L= 28mH
  Peak I<sub>L</sub> = 4.5A, V<sub>GS</sub> = 10V

- ④ Pulse width  $\leq$  300 µs; Duty Cycle  $\leq$  2%

### Case Outline and Dimensions — TO-257AA

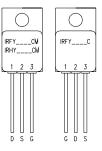


NOTES:

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-257AA.

LEGEND

- D DRAIN
- S SOURCE
- G GATE



CERAMIC EYELETS

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IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105 TAC Fax: (310) 252-7903 Visit us at www.if.com for sales contact information.

Data and specifications subject to change without notice. 04/01